



24LCS61/24LCS62

1K/2K Software Addressable I²C™ Serial EEPROM

PRODUCT OFFERING

Device	Array Size	Voltage Range	Software Write Protection
24LCS61	1K bits	2.5V-5.5V	Entire Array
24LCS62	2K bits	2.5V-5.5V	Lower Half

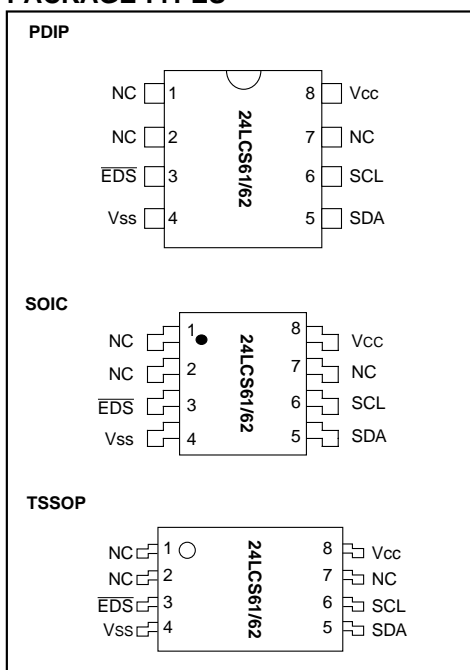
FEATURES

- Low power CMOS technology
 - 1 mA active current typical
 - 10 μ A standby current typical at 5.5V
- Software addressability allows up to 255 devices on the same bus
- 2-wire serial interface bus, I²C compatible
- Automatic bus arbitration
- Wakes up to control code 0110
- General purpose output pin can be used to enable other circuitry
- 100 kHz and 400 kHz compatibility
- Page-write buffer for up to 16 bytes
- 10 ms max write cycle time for byte or page write
- 1,000,000 erase/write cycles guaranteed
- 8-pin PDIP, SOIC or TSSOP packages
- Temperature ranges supported:
 - Industrial (I): -40°C to +85°C

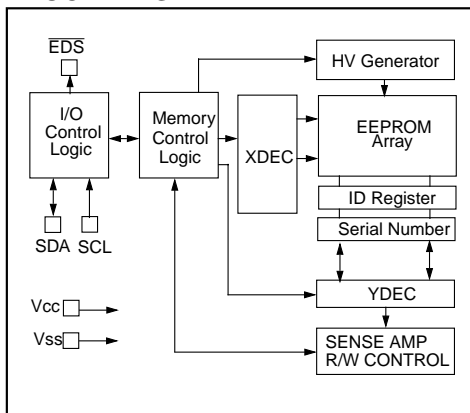
DESCRIPTION

The Microchip Technology Inc. 24LCS61/62 is a 1K/2K bit Serial EEPROM developed for applications that require many devices on the same bus but do not have the I/O pins required to address each one individually. These devices contain an 8 bit address register that is set upon power-up and allows the connection of up to 255 devices on the same bus. When the process of assigning ID values to each device is in progress, the device will automatically handle bus arbitration if more than one device is operating on the bus. In addition, an external open drain output pin is available that can be used to enable other circuitry associated with each individual system. Low current design permits operation with typical standby and active currents of only 10 μ A and 1 mA respectively. The device has a page-write capability for up to 16 bytes of data. The device is available in the standard 8-pin PDIP, SOIC (150 mil), and TSSOP packages.

PACKAGE TYPES



BLOCK DIAGRAM



I²C is a trademark of Philips Corporation.

1.0 ELECTRICAL CHARACTERISTICS

1.1 Maximum Ratings*

V_{CC} 7.0V
 All inputs and outputs w.r.t. V_{SS} -0.6V to V_{CC} +1.0V
 Storage temperature -65°C to +150°C
 Ambient temp. with power applied -65°C to +125°C
 Soldering temperature of leads (10 seconds) .. +300°C
 ESD protection on all pins ≥ 4 kV

***Notice:** Stresses above those listed under "Maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 1-1: PIN FUNCTION TABLE

Name	Function
V _{SS}	Ground
SDA	Serial Data
SCL	Serial Clock
V _{CC}	+2.5V to 5.5V Power Supply
NC	No Internal Connection
EDS	External Device Select Output

TABLE 1-2: DC CHARACTERISTICS

All parameters apply across the specified operating ranges unless otherwise noted.		V _{CC} = +2.5V to +5.5V Industrial (I): T _{amb} = -40°C to +85°C			
Parameter	Symbol	Min.	Max.	Units	Conditions
SCL and SDA pins:					
High level input voltage	V _{IH}	0.7 V _{CC}		V	
Low level input voltage	V _{IL}		.3 V _{CC}	V	
Hysteresis of Schmitt trigger inputs	V _{HYS}	0.05 V _{CC}	—	V	
Low level output voltage (SDA and EDS pins)	V _{OL}		.40	V	I _{OL} = 12 mA, V _{CC} = 4.5V I _{OL} = 8 mA, V _{CC} = 2.5V
Input leakage current	I _{LI}	-10	10	μA	V _{IN} = V _{SS} or V _{CC}
Output leakage current	I _{LO}	-10	10	μA	V _{OUT} = V _{SS} or V _{CC}
Pin capacitance (all inputs/outputs)	C _{IN} , C _{OUT}	—	10	pF	V _{CC} = 5.0V (Note) T _{amb} = 25°C, f = 1 MHz
Operating current	I _{CC} Write	—	4	mA	V _{CC} = 5.5V
	I _{CC} Read	—	1	mA	V _{CC} = 5.5V, SCL = 400 kHz
Standby current	I _{CCS}	—	50	μA	V _{CC} = 5.5V, SDA = SCL = V _{CC} EDS = V _{CC}

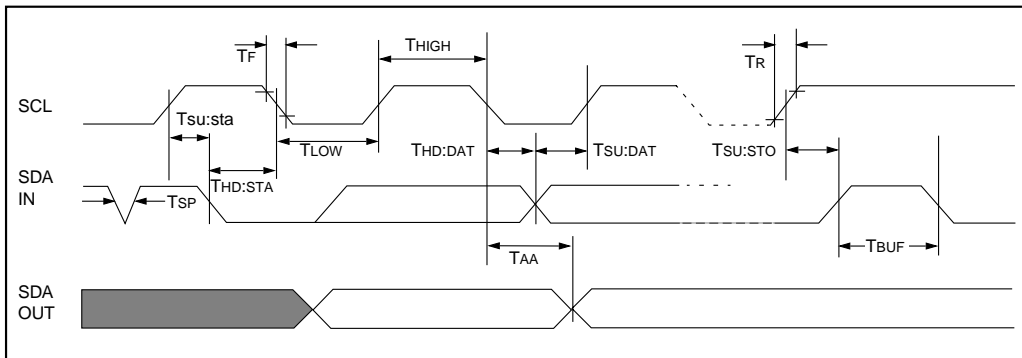
Note: This parameter is periodically sampled and not 100% tested.

TABLE 1-3: AC CHARACTERISTICS

All parameters apply across the specified operating ranges unless otherwise noted.			V _{CC} = +2.5V to 5.5V Industrial (I):			T _{amb} = -40°C to +85°C	
Parameter	Symbol	V _{CC} = 2.5V - 5.5V STD MODE		V _{CC} = 4.5V - 5.5V FAST MODE		Units	Remarks
		Min.	Max.	Min.	Max.		
Clock frequency	FCLK	—	100	—	400	kHz	
Clock high time	T _{HIGH}	4000	—	600	—	ns	
Clock low time	T _{LOW}	4700	—	1300	—	ns	
SDA and SCL rise time	T _R	—	1000	—	300	ns	From V _{IL} to V _{IH} (Note 1)
SDA and SCL fall time	T _F	—	300	—	300	ns	From V _{IH} to V _{IL} (Note 1)
START condition hold time	T _{HD:STA}	4000	—	600	—	ns	After this period the first clock pulse is generated
START condition setup time	T _{SU:STA}	4700	—	600	—	ns	Only relevant for repeated START condition
Data input hold time	T _{HD:DAT}	0	—	0	—	ns	(Note 2)
Data input setup time	T _{SU:DAT}	250	—	100	—	ns	
STOP condition setup time	T _{SU:STO}	4000	—	600	—	ns	
Output valid from clock	T _{AA}	—	3500	—	900	ns	(Note 2)
Bus free time	T _{BUF}	4700	—	1300	—	ns	Time the bus must be free before a new transmission can start
Output fall time (from 0.7 V _{CC} to 0.3 V _{CC})	T _{OF}	—	250	20 + 0.1 C _B	250	ns	(Note 1), C _B ≤ 100 pF
Input filter spike suppression (SDA and SCL pins)	T _{SP}	—	50	—	50	ns	(Notes 1, 3)
Write cycle time	T _{WC}	—	10	—	10	ms	Byte or Page mode
Endurance		1M	—	1M	—	cycles	25°C, V _{CC} = 5.0V, Block Mode (Note 4)

Note 1: Not 100% tested. C_B = total capacitance of one bus line in pF.

- 2:** As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.
- 3:** The combined T_{SP} and V_{HYS} specifications are due to Schmitt trigger inputs which provide improved noise spike suppression. This eliminates the need for a TI specification for standard operation.
- 4:** This parameter is not tested but guaranteed by characterization. For endurance estimates in a specific application, please consult the Total Endurance Model which can be obtained on our website.

FIGURE 1-1: BUS TIMING DATA

2.0 PIN DESCRIPTIONS

2.1 SDA (Serial Data)

This is a bi-directional pin used to transfer addresses and data into and data out of the device. It is an open drain terminal, therefore the SDA bus requires a pull-up resistor to Vcc (typical 10 k Ω for 100 kHz, 2 k Ω for 400 kHz).

For normal data transfer SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the START and STOP conditions. The SDA pin has Schmitt trigger and filter circuits which suppress noise spikes to assure proper device operation even on a noisy bus.

2.2 SCL (Serial Clock)

This input is used to synchronize the data transfer from and to the device. The SCL pin has Schmitt trigger and filter circuits which suppress noise spikes to assure proper device operation even on a noisy bus.

2.3 EDS (External Device Select)

The External Device Select ($\overline{\text{EDS}}$) pin is an open drain output that is controlled by using the OE bit in the control byte. It can be used to enable other circuitry when the device is selected. A pull-up resistor must be added to this pin for proper operation. This pin should not be pulled up to a voltage higher than Vcc+1V. See Section 9.0 for more details.

3.0 BUS CHARACTERISTICS

The following **bus protocol** has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH will be interpreted as a START or STOP condition.

Accordingly, the following bus conditions have been defined (Figure 3-1).

3.1 Bus not Busy (A)

Both data and clock lines remain HIGH.

3.2 Start Data Transfer (B)

A HIGH to LOW transition of the SDA line while the clock (SCL) is HIGH determines a START condition. All commands must be preceded by a START condition.

3.3 Stop Data Transfer (C)

A LOW to HIGH transition of the SDA line while the clock (SCL) is HIGH determines a STOP condition. All operations must be ended with a STOP condition.

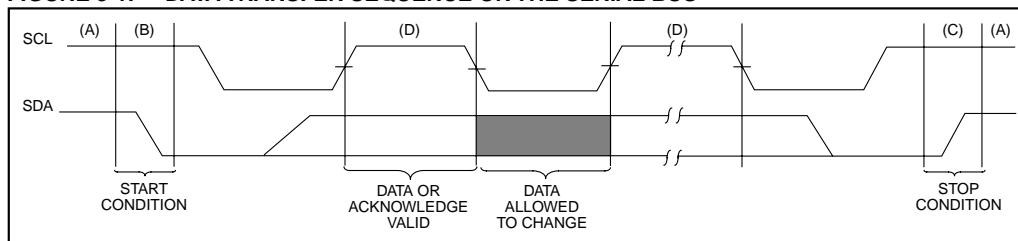
3.4 Data Valid (D)

The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal.

The data on the line must be changed during the LOW period of the clock signal. There is one bit of data per clock pulse.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of data bytes transferred between the START and STOP conditions is determined by the master device and is theoretically unlimited, although only the last sixteen will be stored when doing a write operation. When an overwrite does occur it will replace data in a first in first out fashion.

FIGURE 3-1: DATA TRANSFER SEQUENCE ON THE SERIAL BUS



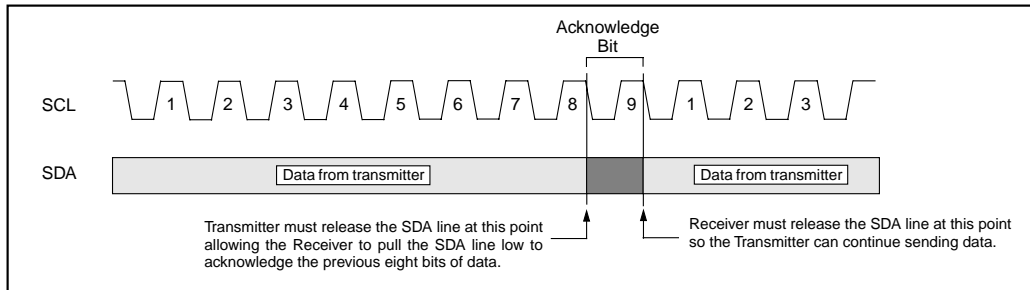
3.5 Acknowledge

Each receiving device, when addressed, is required to generate an acknowledge after the reception of each byte. The master device must generate an extra clock pulse which is associated with this acknowledge bit.

Note: The 24LCS61/62 does not generate any acknowledge bits if an internal programming cycle is in progress.

The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. A master must signal an end of data to the slave by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave must leave the data line HIGH to enable the master to generate the STOP condition (Figure 3-2).

FIGURE 3-2: ACKNOWLEDGE TIMING



4.0 FUNCTIONAL DESCRIPTION

The 24LCS61/62 supports a bi-directional 2-wire bus and data transmission protocol compatible with the I²C protocol. The device is configured to reside on a common I²C bus with up to 255 total 24LCS61/62 devices on the bus. Each device has a unique serial number assigned to it when delivered from the factory. In an actual system, this serial number will be used to assign a separate 8-bit ID byte to each device in the system. After an ID byte is assigned to each device in the system, standard read and write commands can be sent to each device individually.

4.1 Device Serial Number

The device serial number is stored in a 48-bit (6 byte) register that is separate from the data array. The serial number register is non-volatile and cannot be changed by the user. Before shipment from the factory, this register is programmed with a unique value for every device. The 48 bit register allows for $2.8 \cdot 10^{14}$ different combinations. The serial number is used at power-up to assign the device an ID byte which is then used for all standard read and write commands sent to that specific device.

4.2 Device ID Byte

The Device ID byte is an 8-bit value that provides the means for every device on the bus to be accessed individually. The ID byte is stored in a RAM register separate from the data array. The ID byte register will always default to address 00 upon power-up.

4.3 Device Addressing

Each command to the device must begin with a start bit. A control byte is the first byte received following the start condition from the master device (Figure 4-1). The control byte consists of a four-bit control code, the OE bit, and three command select bits. For the 24LCS61/62, the control code is set to 0110 binary for all operations. The device will not acknowledge any commands sent with any other control code. The next bit is the Output Enable (OE) bit. This bit controls the operation of the $\overline{\text{EDS}}$ pin. See Section 9.0 for more details. The last three bits of the control byte are the command select bits (C0-C2). The command select bits determine which command will be executed. See Table 4-1. Following a valid control byte, the 24LCS61/62 will acknowledge the command.

FIGURE 4-1: CONTROL BYTE FORMAT

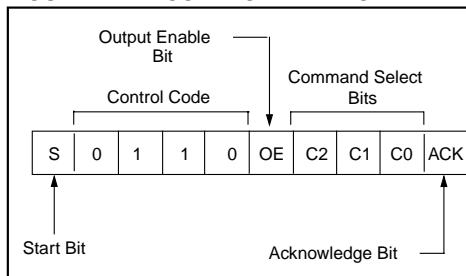


TABLE 4-1: COMMAND CODES

Command	Command Select Bits (C2 C1 C0)
Set Write Protection Fuse	000
Read	001
Write (Byte or Page)	010
Assign Address	100
Clear Address	110

5.0 ASSIGNING THE ID BYTE

The 24LCS61/62 device contains a special register which holds an 8-bit ID byte that is used as an address to communicate with a specific device on the bus. All read and write commands to the device must include this ID address byte. Upon power-up, the ID byte will default to 00h. Communicating with the device using the default address is typically done only at testing or programming time and not when it is connected to a bus with more than one device. Before the device can be used on a common bus with other devices, a unique ID byte address must be assigned to every device.

5.1 Assign Address Command

The ID byte is assigned by sending the Assign Address command. This command queries any device connected to the bus and utilizing the automatic bus arbitration feature, assigns an ID byte to the device that remains on the bus after arbitration is complete. Once a device has been assigned an ID byte, it will no longer respond to Assign Address commands until power is cycled or the Clear Address command is sent. The Assign Address command must be repeated for each device on the bus until all devices have been assigned an ID byte.

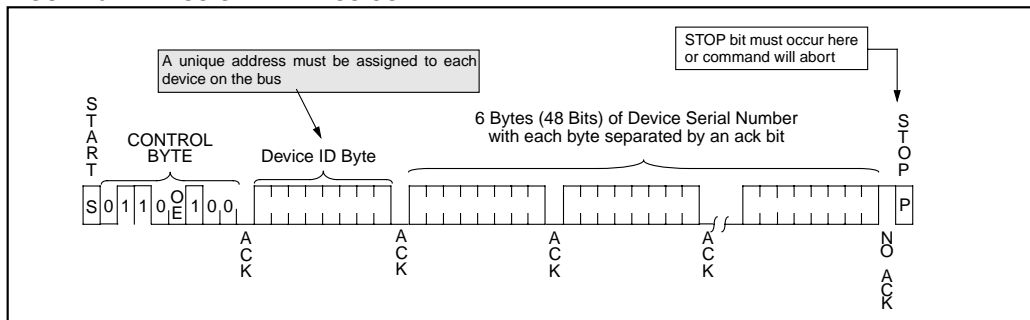
The format for the Assign Address command is shown in Figure 5-1. The command consists of the control byte, the ID byte to be assigned to the device remaining when the arbitration is complete, and 48 bits of data being transmitted by devices on the bus. If the OE bit is set to a 1, then any device who has not been assigned an address will assert their respective EDS pin after the acknowledge bit following the Device ID byte. After the control byte and ID byte are sent, each device will begin to transmit its unique 48-bit serial number. The 24LCS61/62 must acknowledge the control byte and

the device ID byte, and the master must acknowledge each byte of the serial number transmitted by the device. As each bit is clocked out, each device will monitor the bus to detect if another device is also transmitting. If any device is outputting a logic '1' on the bus and it detects that the bus is at a logic '0', then it assumes that another device is controlling the bus. As soon as any device detects that it is not controlling the bus it will immediately stop transmitting data and return to standby mode. The master must end the command by sending a no ack after all 6 bytes of the serial number have been transmitted, followed by a Stop bit. Sending the Stop bit in any other position of the command will result in the command aborting and all devices releasing the bus with no address assigned. If a device transmits its entire 48 bit serial number without releasing the bus to another device, then the ID byte transmitted within the command is transferred to the internal ID byte register upon receipt of the Stop bit and it will now respond only to commands that contain this ID byte (or the Clear Address command). Once a device has been assigned an ID byte, it will no longer respond to Assign Address commands until power is cycled or the Clear Address command is sent.

This process of assigning ID bytes is repeated by the controller until no more devices respond to the Assign Address command. At this point, all devices on the bus have been assigned an ID byte and standard read and write commands can be executed to each individual device.

The ID byte is stored in a volatile SRAM register, and if power is removed from the device or the Clear Address command is sent, then the ID byte will default to address 00 and the process of assigning an ID value must be repeated.

FIGURE 5-1: ASSIGN ADDRESS COMMAND

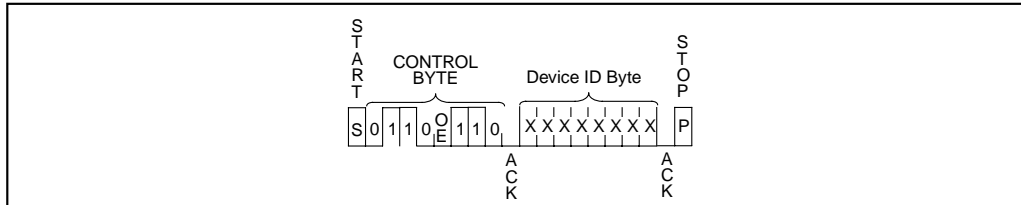


5.2 Clear Address Command

The clear address command will clear the device ID byte from all devices on the bus and will enable all devices to respond to the Assign Address command. The master must end the command by sending an ack

after 8 don't care bits have been transmitted, followed by a Stop bit. Sending the Stop bit in any other position of the command will result in the command aborting and the device releasing the bus.

FIGURE 5-2: CLEAR ADDRESS COMMAND



5.3 Operation State Diagram

The diagram below shows the state diagram for basic operation of the 24LCS61/62. This diagram shows pos-

sible states and operational flow once power is applied to the device. Table 5-1 summarizes operation of each command for the assigned and unassigned states.

FIGURE 5-3: OPERATIONAL STATE DIAGRAM

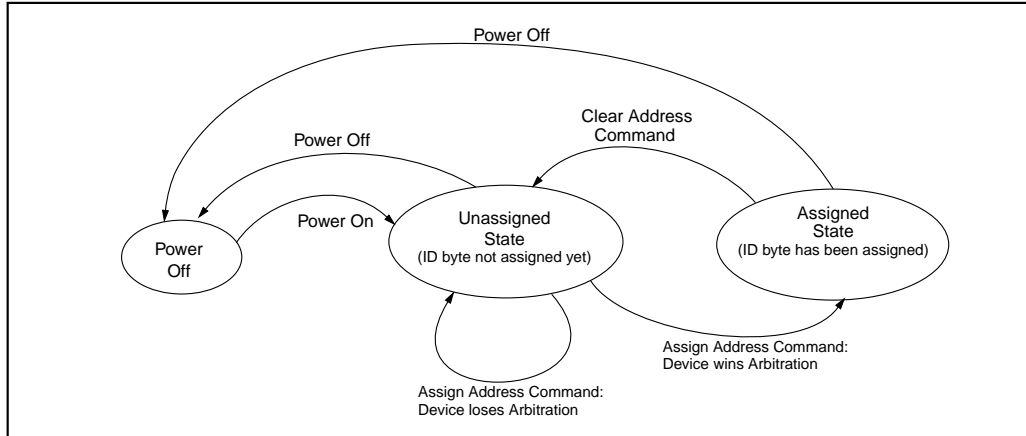


TABLE 5-1: COMMAND SUMMARY TABLE

Command	Result if Device Has Not Yet Been Assigned an ID Byte	Result if Device Has Already Been Assigned an ID Byte
Assign Address command	If device wins arbitration, then ID byte will become xxh. If device loses arbitration, then ID byte will revert back to 00h.	Device will not acknowledge command.
Clear Address command	Device will remain with ID byte set to 00h.	Device ID byte will revert back to 00h and will then acknowledge Assign Address commands.
Read or Write command with ID byte set to 00h	Since the default ID byte for the device is 00h, the device will execute the command.	Device will acknowledge the control byte, but it will not acknowledge any further bytes and will not respond to the command.
Read or Write command with ID byte set to xxh (other than 00h)	Device will acknowledge the control byte, but it will not acknowledge any further bytes and will not respond to the command.	If the device ID byte matches the ID byte in the command (xxh), the device will execute the command. If the device ID byte does not match the ID byte in the command, then the device will acknowledge the control byte, but it will not acknowledge any further bytes and will not respond to the command.
Set Write Protect command with ID byte set to 00h	Since the default ID address for the device is 00h, the device will execute the command.	Device will acknowledge the control byte, but it will not acknowledge any further bytes and will not respond to the command.
Set Write Protection command with ID byte set to xxh (other than 00h)	Device will acknowledge the control byte, but it will not acknowledge any further bytes and will not respond to the command.	If the device ID byte matches the ID byte in the command (xxh), the device will execute the command. If the device ID byte does not match the ID byte in the command, then the device will acknowledge the control byte, but it will not acknowledge any further bytes and will not respond to the command. Note: Once this command has been executed successfully for a device, the device will no longer acknowledge any part of this command again.

6.0 WRITE OPERATIONS

6.1 Byte Write

Following the start signal from the master, the control byte for a write command is sent by the master transmitter. The device will acknowledge this control byte during the ninth clock pulse. The next byte transmitted by the master is the ID byte for the device. After receiving another acknowledge signal from the 24LCS61/62, the master device will transmit the address and then the data word to be written into the addressed memory location. The 24LCS61/62 acknowledges between each byte, and the master then generates a stop condition. This initiates the internal write cycle, and during this time the 24LCS61/62 will not generate acknowledge signals (Figure 6-1).

6.2 Page Write

The control byte, ID byte, word address, and the first data byte are transmitted to the 24LCS61/62 in the same way as in a byte write. But, instead of generating a stop condition, the master transmits up to 15 additional data bytes to the 24LCS61/62, which are temporarily stored in the on-chip page buffer and will be written into the memory after the master has transmitted a stop condition. If the master should transmit more

than 16 bytes prior to generating the stop condition, the address counter will roll over and the previously received data will be overwritten. As with the byte write operation, once the stop condition is received an internal write cycle will begin (Figure 6-2) and the 24LCS61/62 will not generate acknowledge.

6.3 Low Voltage Write Protection

The 24LCS61/62 employs a VCC threshold detector circuit which disables the internal erase/write logic, if the VCC is below 1.5 volts at nominal conditions.

6.4 Set Write Protection Command

The Set Write Protection command allows the user to write protect a portion of the array. For the 24LCS61 this command will write protect the entire array. For the 24LCS62 this command will protect the lower half of the array. This command is illustrated in Figure 6-3. **This is a one time only command and cannot be reversed once the protection fuse has been set.** Once the Write protect feature has been set, the device will no longer acknowledge the control byte (or any of the other bytes) of this command. The STOP bit of this command initiates an internal write cycle, and during this time the 24LCS61/62 will not generate acknowledge signals.

FIGURE 6-1: BYTE WRITE

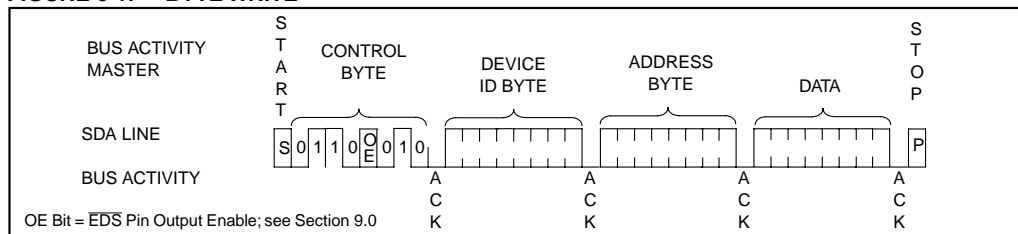


FIGURE 6-2: PAGE WRITE

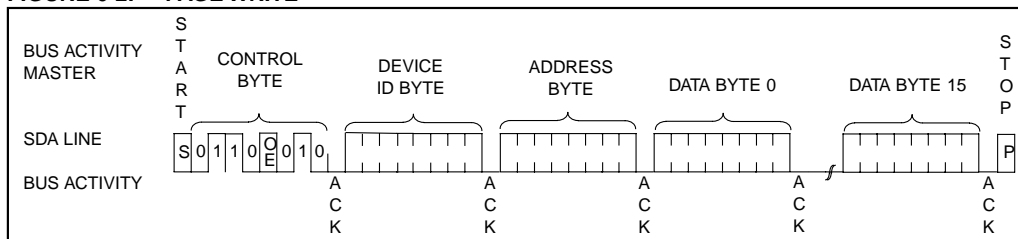
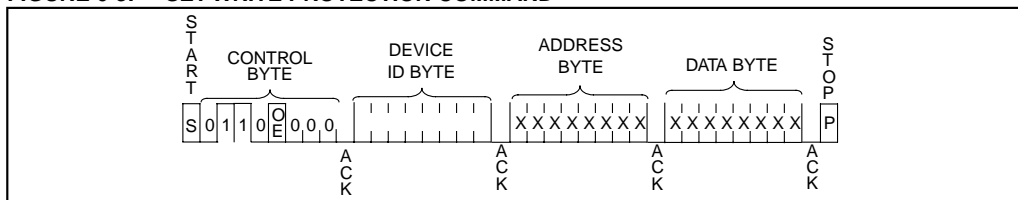


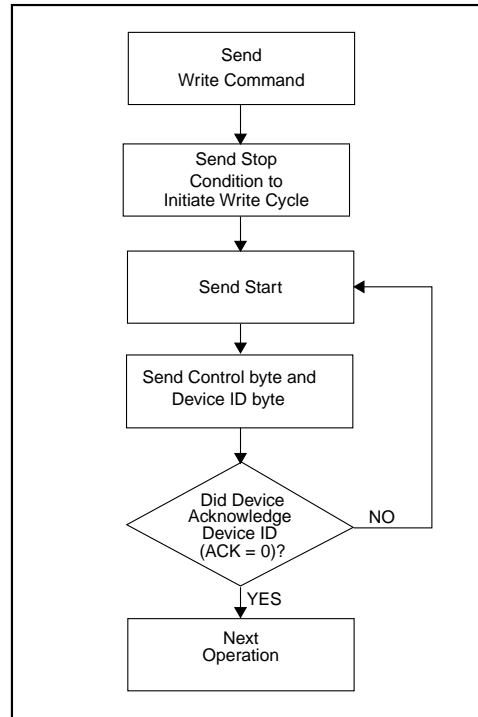
FIGURE 6-3: SET WRITE PROTECTION COMMAND



7.0 ACKNOWLEDGE POLLING

Since the device will not acknowledge during a write cycle, this can be used to determine when the cycle is complete (this feature can be used to maximize bus throughput). Once the stop condition for a write command has been issued from the master, the device initiates the internally timed write cycle. ACK polling can be initiated immediately. This involves the master sending a start condition followed by the control byte for a write command and then sending the Device ID byte for that particular device. If the device is still busy with the write cycle, then no ACK will be returned after the Device ID byte. If no ACK is returned, then the start bit, control byte and ID byte must be re-sent. If the cycle is complete, then the device will return the ACK and the master can then proceed with the next command. See Figure 7-1 for flow diagram.

FIGURE 7-1: ACKNOWLEDGE POLLING FLOW



8.0 READ OPERATIONS

Read operations are initiated in a similar way as the write operations. There are three basic types of read operations: current address read, random read, and sequential read.

8.1 Current Address Read

The 24LCS61/62 contains an address counter that maintains the address of the last word accessed, internally incremented by one. Therefore, if the previous read access was to address n , the next current address read operation would access data from address $n + 1$. Upon receipt of the correct control byte and ID byte, the 24LCS61/62 issues an acknowledge and transmits the eight bit data word. The master will not acknowledge the transfer but does generate a stop condition and the 24LCS61/62 discontinues transmission (Figure 8-1).

8.2 Random Read

Random read operations allow the master to access any memory location in a random manner. To perform this type of read operation, first the word address must be set. This is done by sending the word address to the 24LCS61/62 as part of a write operation. After the ID byte and word address are sent, the master generates

a start condition following the acknowledge. This terminates the write operation, but not before the internal address pointer is set. Then the master sends the control byte and ID byte for a read command. The 24LCS61/62 will then issue an acknowledge and transmits the eight bit data word. The master will not acknowledge the transfer but does generate a stop condition and the 24LCS61/62 discontinues transmission (Figure 8-2).

8.3 Sequential Read

Sequential reads are initiated in the same way as a random read except that after the 24LCS61/62 transmits the first data byte, the master issues an acknowledge as opposed to a stop condition in a random read. This directs the 24LCS61/62 to transmit the next sequentially addressed 8-bit word (Figure 8-3).

To provide sequential reads the 24LCS61/62 contains an internal address pointer which is incremented by one at the completion of each operation. This address pointer allows the entire memory contents to be serially read during one operation. The internal address pointer will automatically roll over from address 7Fh (24LCS61) or FFh (24LCS62) to address 00h.

FIGURE 8-1: CURRENT ADDRESS READ

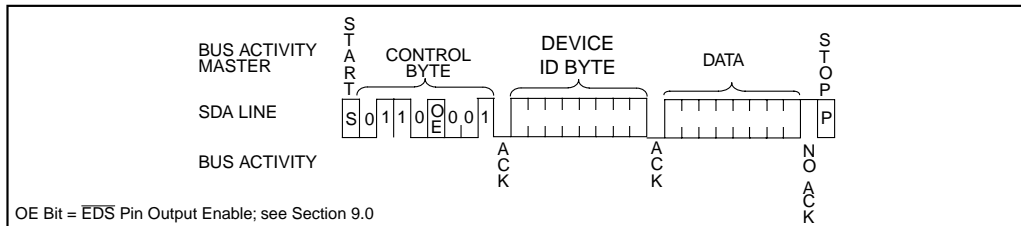


FIGURE 8-2: RANDOM READ

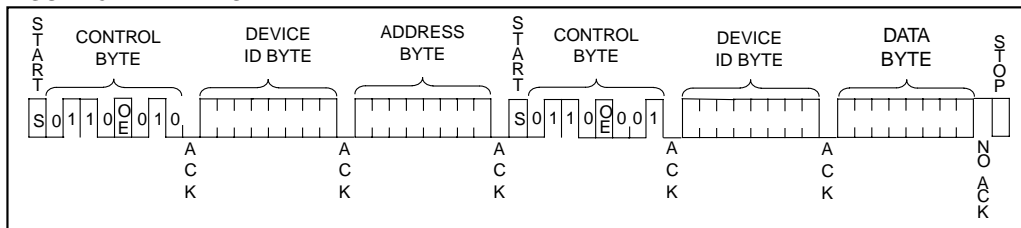
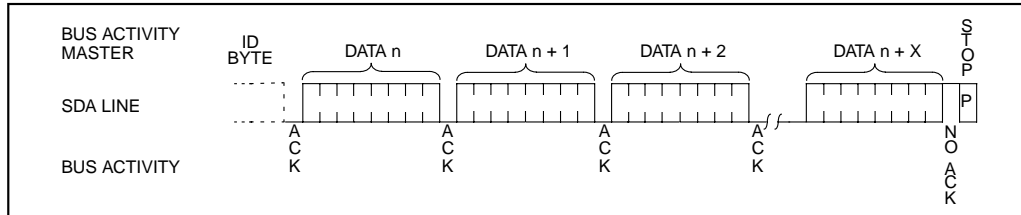


FIGURE 8-3: SEQUENTIAL READ

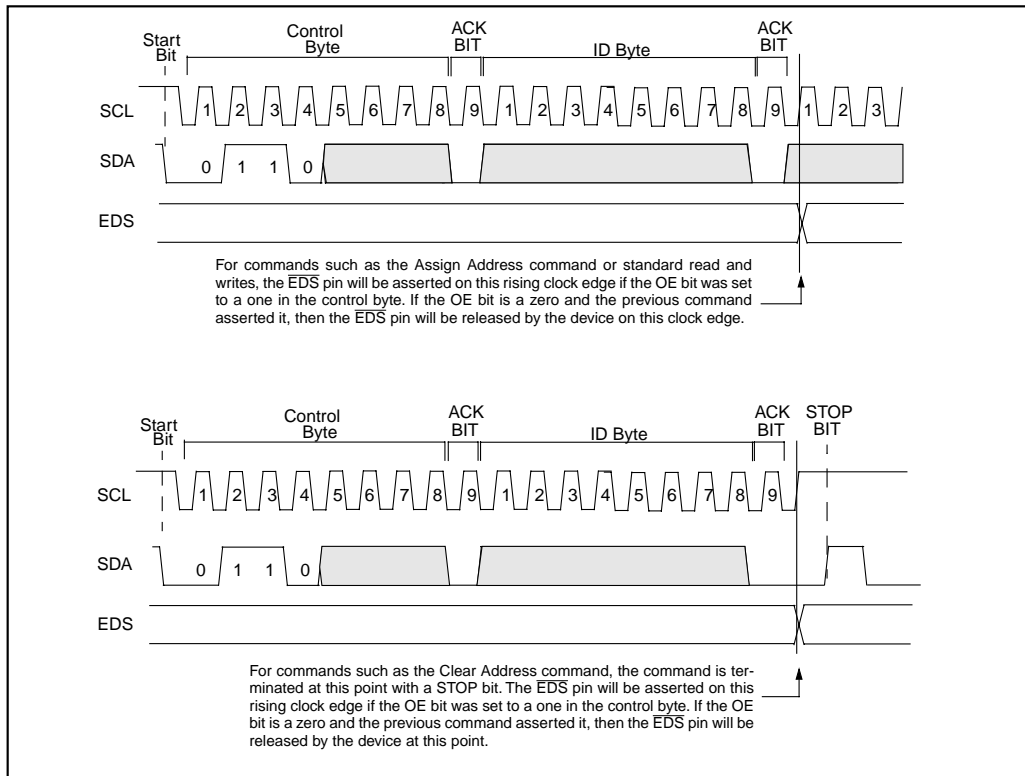


9.0 EXTERNAL DEVICE SELECT (EDS) PIN AND OUTPUT ENABLE (OE) BIT

The External Device Select ($\overline{\text{EDS}}$) pin is an open drain, low active output and may be used by the system designer for functions such as enabling other circuitry when the 24LCS61/62 is being accessed. Because the pin is an open drain output, a pull-up resistor is required for proper operation of this pin. When the device is powered up, the $\overline{\text{EDS}}$ pin will always be in the high impedance state (off). The $\overline{\text{EDS}}$ pin function is controlled by using the output enable (OE) bit in the control byte of each command. If the OE bit is high, the $\overline{\text{EDS}}$ pin is enabled and if the OE bit is low the pin is disabled. For the Assign Address command and standard read or

write commands, the $\overline{\text{EDS}}$ pin will pull low (providing that the OE bit is set high) on the rising clock edge after the ack bit following the ID byte. See Figure 9-1. For commands such as the Clear Address command, the $\overline{\text{EDS}}$ pin will change states at the rising clock edge just before the Stop bit. It is also possible to control the $\overline{\text{EDS}}$ pin by sending a partial command such as the control byte and ID byte for a write command followed by the Stop bit. The $\overline{\text{EDS}}$ pin would change states just before the Stop bit as shown in the lower portion of Figure 9-1. When the $\overline{\text{EDS}}$ pin has changed states, it is latched and will remain in a given state until another command is sent to the device with the OE bit set to change the state of the pin, or power to the device is removed.

FIGURE 9-1: $\overline{\text{EDS}}$ PIN OPERATION



NOTES:

24LCS61/62 PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office..

24LCS61/62	—	/P	Package:	P = Plastic DIP (300 mil Body), 8-lead
				SN = Plastic SOIC (150 mil Body)
				ST = TSSOP, 8-lead
				OT = SOT-23, 5 lead
			Temperature Range:	Blank = 0°C to +70°C
				I = -40°C to +85°C
				E = -40°C to +125°C
			Device:	24AA00 128 bit 1.8V I ² C Serial EEPROM
				24AA00 128 bit 1.8V K I ² C Serial EEPROM (Tape and Reel)
				T
				24LC00 128 bit 2.5V I ² C Serial EEPROM
				24LC00T 128 bit 2.5V K I ² C Serial EEPROM (Tape and Reel)
				24C00 128 bit 5.0V I ² C Serial EEPROM
				24C00T 128 bit 5.0V K I ² C Serial EEPROM (Tape and Reel)

Sales and Support

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office (see last page)
 2. The Microchip Corporate Literature Center U.S. FAX: (602) 786-7277
 3. The Microchip's Bulletin Board, via your local CompuServe number (CompuServe membership NOT required).
- Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

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6/11/98



Microchip received ISO 9001 Quality System certification for its worldwide headquarters, design, and wafer fabrication facilities in January, 1997. Our field-programmable PICmicro™ 8-bit MCUs, Serial EEPROMs, related specialty memory products and development systems conform to the stringent quality standards of the International Standard Organization (ISO).